



General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

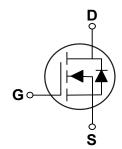
BV _{DSS}	R _{DS(ON)}	I _D
100 V	3.6 mΩ	140 A

Features

- $R_{DS(ON)} \le 3.6 m\Omega @V_{GS} = 10V$
- · Improved dv/dt capability
- · Fast switching
- · Green Device Available

PPAK5X6 Pin Configuration





Applications

- Networking
- · Load Switch
- · LED applications
- Quick Charger

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
1	Drain Current – Continuous (T _C =25°C)	140	Α
I _D	Drain Current – Continuous (T _C =100°C)	88	Α
I _{DM}	Drain Current – Pulsed (NOTE 1)	560	Α
EAS	Single Pulse Avalanche Energy (NOTE 2)	370	mJ
IAS	Single Pulse Avalanche Current (NOTE 2)	86	Α
P_D	Power Dissipation (T _C =25°C)	192	W
T_J	Operating Junction Temperature Range	-55 to 150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
/larking Code		NM3P6	

Thermal Characteristics					
Symbol Parameter Typ. Max.			Unit		
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		62	°C/W	
$R_{ heta JC}$	Thermal Resistance Junction to Case		0.65	°C/W	





Electrical Characteristics (T_{.1}=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	100			V
I _{DSS} Dr	IDrain-Source Leakage Current	V_{DS} =80V , V_{GS} =0V , T_J =25°C		-	1	uA
		V_{DS} =80V , V_{GS} =0V , T_{J} =85 $^{\circ}$ C			10	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	IStatic Drain-Source On-Resistance	V_{GS} =10V , I_D =20A		3.1	3.6	- mΩ
		V _{GS} =4.5V , I _D =15A		3.9	5.1	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	1.2	1.6	2.5	V
gfs	Forward Transconductance	V_{DS} =10V , I_{D} =3A		22		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge	V -50V V -10V L -70A		65		
Q_gs	Gate-Source Charge	V_{DS} =50V , V_{GS} =10V , I_{D} =70A (NOTE 3 \ 4)		9.5		nC
Q_{gd}	Gate-Drain Charge	(NOTE 3 * 4)		14		
T _{d(on)}	Turn-On Delay Time	V_{DD} =50V , V_{GS} =10V , R_{G} =6 Ω , I_{D} =70A (NOTE 3 \cdot 4)		24		
T _r	Rise Time			20		nS
$T_{d(off)}$	Turn-Off Delay Time			45		113
T _f	Fall Time			25		
C _{iss}	Input Capacitance	V _{DS} =50V , V _{GS} =0V , F=1MHz		4000		
C _{oss}	Output Capacitance			750		pF
C_{rss}	Reverse Transfer Capacitance			10		
R_g	Gate resistance	V_{GS} =0V , V_{DS} =0V , F=1MHz		1.8		Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V,Force Current			140	Α
I _{SM}	Pulsed Source Current	V _G -V _D -0V , Force Current			280	Α
V_{SD}	Diode Forward Voltage	V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C			1	V
t _{rr}	Reverse Recovery Time	V _R =100V , I _S =10A ,		210		nS
Q_{rr}	Reverse Recovery Charge	dl/dt=100A/us , T _J =25°C		490		nC

NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =50V, V_{GS} =10V, L=0.1mH, I_{AS} =86A, R_{G} =25 Ω , starting T_{J} =25 $^{\circ}$ C.
- 3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 4. Essentially independent of operating temperature.





Characteristics Curves

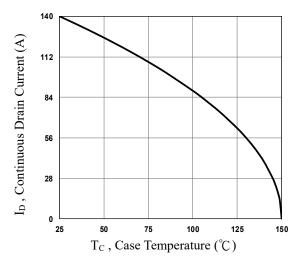


Fig.1 Continuous Drain Current vs. Tc

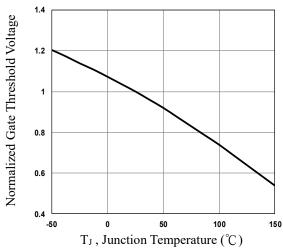


Fig.3 Normalized V_{th} vs. T_J

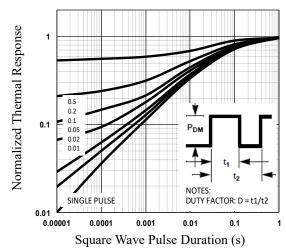


Fig.5 Normalized Transient Impedance

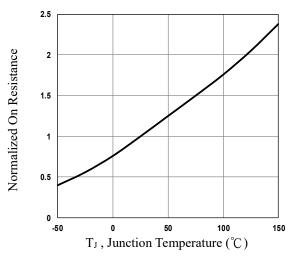


Fig.2 Normalized RDSON vs. T_J

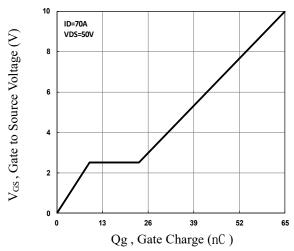


Fig.4 Gate Charge Characteristics

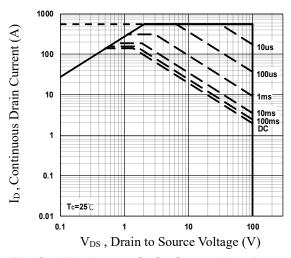


Fig.6 Maximum Safe Operation Area





Characteristics Curves

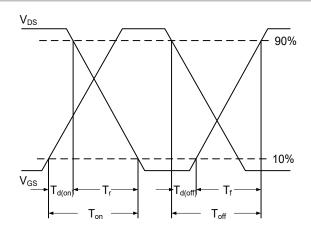
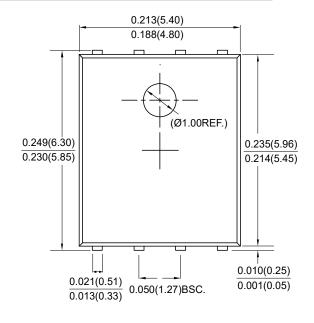
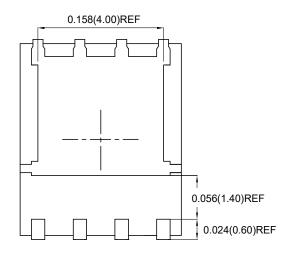
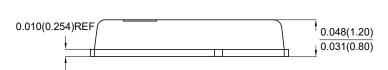


Fig.7 Switching Time Waveform

Package Outline Dimensions









PPAK5X6

Dimensions in inches and (millimeters)





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